Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	210	faris near sadeg	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:42
S2	6	(("5786629") or ("6257564") or ("5534073")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 08:36
S3	2	"5967577"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/10/01 08:36
S4	7	("3404845" | "4049484" | "4787290" | "5243841" | "5284287" | "5516125" | "5749614").PN.	USPAT	OR	ON	2003/10/01 08:37
S5	4	("2247623" | "3138508" | "3377096" | "3926710").PN.	USPAT	OR	ON	2003/10/01 08:38
S6	19	"4049484".URPN.	USPAT	OR	ON	2003/10/01 08:39
S7	8	("2953808" | "3523707" | "3631796" | "3743340" | "4049484" | "4674785" | "4712784" | "4799722").PN.	USPAT	OR	ON	2003/10/01 08:40
S8	1	"2953808".PN.	USPAT	OR	ON	2003/10/01 08:41
S9	7	"4799722".URPN.	USPAT	OR	ON	2003/10/01 08:41
S10	11	("1575892" | "2852253" | "2984398" | "3137390" | "3334896" | "3421753" | "3504910" | "3617048" | "3815762" | "4216955" | "4327906").PN.	USPAT	OR	ON	2003/10/01 08:42
S11	7	"4881770".URPN.	USPAT	OR	ON	2003/10/01 08:43
S12	12	("2964007" | "3226255" | "3910621" | "4506820" | "4739919" | "4745679" | "4787662" | "4881770" | "5284287" | "5749614" | "5834062" | "5839641").PN.	USPAT	OR	ON	2003/10/01 08:43
S13	6	("1842383" | "3556578" | "4352440" | "4452557" | "4479298" | "4703966").PN.	USPAT	OR	ON	2003/10/01 08:50
S14	0	"5967577".URPN.	USPAT	OR	ON	2003/10/01 08:46
S15	0	"5967577".URPN.	USPAT	OR	ON	2003/10/01 08:46

S16	0	"45121".URPN.	USPAT	OR	ON	2003/10/01 08:46
S17	0	"45121".URPN.	USPAT	OR	ON	2003/10/01 08:46
S18	1365	(294/64.1).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:28
S19	3	("3893881" | "5177857" | "6173648").PN.	USPAT	OR	ON	2003/10/01 08:52
S20	2	"6336492".URPN.	USPAT	OR	ON	2003/10/01 08:53
S21	20	("3221910" | "3831992" | "4461328" | "4468974" | "4478094" | "4500247" | "4565100" | "4604024" | "4852620" | "4909992" | "4952518" | "5063790" | "5192511" | "5293179" | "5334352" | "5343909" | "5392914" | "5497670" | "5736105" | "5807524").PN.	USPAT	OR	ON	2003/10/01 08:54
S22	12	("2964007" | "3226255" | "3910621" | "4506820" | "4739919" | "4745679" | "4787662" | "4881770" | "5284287" | "5749614" | "5834062" | "5839641").PN.	USPAT	OR	ON	2003/10/01 08:56
S23	3	("4131267" | "4684113" | "4693458").PN.	USPAT	OR	ON	2003/10/01 08:59
S24	3	("3102751" | "3865420" | "4047532").PN.	USPAT	OR	ON	2003/10/01 09:03
S25	1	"4846517".URPN.	USPAT	OR	ON	2003/10/01 09:03
S26	9	("1945481" | "2694337" | "2782574" | "2814233" | "2895706" | "3107078" | "3180608" | "4448404" | "4468017").PN.	USPAT	OR	ON	2003/10/01 09:05
S27	16	"4721462".URPN.	USPAT	OR	ON	2003/10/01 09:06
S28	3	("3523707" | "3888725" | "4375126").PN.	USPAT	OR	ON	2003/10/01 09:09
S29	9	"4452557".URPN.	USPAT	OR	ON	2003/10/01 09:09
S30	13	"2572640".URPN.	USPAT	OR	ON	2003/10/01 09:16
S31	273	(239/553.5).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:34

S32	491	(156/538).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2003/10/01 09:35
S33	6	(("5967577") or ("6336492") or ("5564682")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/04/27 10:06
S34	0	bunding and carrying and (shoulder near sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 10:59
S35	0	bunding and carrying and (sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 10:59
S36	1	bundling and carrying and (shoulder near sash)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/05/05 11:01
S37	167	(294/152).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/05/05 11:01
S38	100	(294/64.3).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/27 21:27
S39	64	(294/64.2).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/27 21:27
S40	1	silicon and (vaccum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:43

S41	0	(semiconductor near material) and (vaccum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:43
S42	1	(semiconductor near material) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:44
S43	1	(semiconductor near materials) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:45
S44	3	(semiconductor same material) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:51
S45	0	(Si-oxide) and (vaccum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:52
S46	2	(Si-oxide) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:53
S47	6192	(Silicon) and (vacuum near system)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S48	159	(Silicon) and (vacuum near system) and (vacuum near suction)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:54
S49	1	S48 and "294"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S50	8	S48 and "414"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 22:55

S51	2258	(Silicon S-oxide) and (vacuum near system) and body	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04
S52	2	S51 and "294"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/27 23:04